

## Small Signal MOSFET 380mAmps, 60 Volts N-Channel

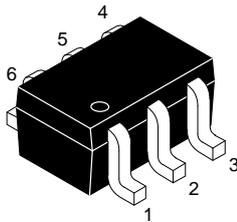
### FEATURES:

- ESD Protected
- We declare that the material of product compliance with RoHS requirements and Halogen Free.

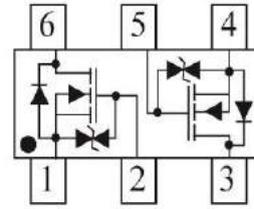
### APPLICATIONS:

- Low Side Load Switch
- Level Shift Circuits
- DC-DC Converter

### Circuit Diagram & Pin Configuration:



SOT363/SC-88



### DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
2N7002KDW1-S03T	72K	3000/Tape&Reel

### MAXIMUM RATINGS(Ta = 25°C)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	VDSS	60	Vdc
Gate-Source Voltage	VGS	±20	Vdc
Drain Current	ID		mAdc
– Steady State TA = 25°C		320	
TA = 85°C		230	
– t<5s TA = 25°C		380	
TA = 85°C		270	
Pulsed Drain Current (tp=10µs)	IDM	1.5	A
Source Current (Body Diode)	IS	300	mA

**THERMAL CHARACTERISTICS**

Parameter	Symbol	Limits	Unit
Total Device Dissipation(Note 1)	PD		mW
– Steady State		300	
– t<5s		420	
Junction-to-Ambient(Note 1)	R $\theta$ JA		°C/W
– Steady State		417	
– t<5s		300	
Lead Temperature for Soldering Purposes (1/8 " from case for 10 s)	TL	260	°C
Junction and Storage temperature	TJ,Tstg	-55~+150	°C
Gate-Source ESD Rating(HBM, Method 3015)	ESD	2000	V

1. FR-5 = 1.0×0.75×0.062 in.

**ELECTRICAL CHARACTERISTICS (Ta= 25°C)**
**OFF CHARACTERISTICS**

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain–Source Breakdown Voltage (VGS = 0, ID = 250 $\mu$ Adc)	VBRDSS	60	-	-	Vdc
Drain–to–Source Breakdown Voltage Temperature Coefficient	VBRDSS/TJ	-	71	-	mV/°C
Zero Gate Voltage Drain Current (VGS = 0, VDS = 60 Vdc)	IDSS	-	-	1.0	$\mu$ Adc
TJ = 25°C				500	
(VGS = 0, VDS = 50 Vdc)		-	-	100	nAdc
Gate–Body Leakage Current, Forward (VGS = 20 Vdc)	IGSSF	-	-	10	$\mu$ Adc
Gate–Body Leakage Current, Reverse (VGS = - 20 Vdc)	IGSSR	-	-	-10	$\mu$ Adc

**ON CHARACTERISTICS (Note 2)**

Gate Threshold Voltage (VDS = VGS, ID = 250 $\mu$ Adc)	VGS(th)	1.0	-	2.5	Vdc
Negative Threshold Temperature Coefficient	VGS(TH)/TJ	-	4	-	mV/°C
Static Drain–Source On–State Resistance (VGS = 10 Vdc, ID = 500 mAdc)	RDS(on)	-	-	2.3	$\Omega$
(VGS = 5.0 Vdc, ID = 50 mAdc)				2.7	
Forward Transconductance (VDS = 5.0 Vdc, ID = 200 mAdc)	gfs	80	-	-	mS

**DYNAMIC CHARACTERISTICS**

Input Capacitance (VDS = 25 Vdc, VGS = 0, f = 1.0 MHz)	Ciss	-	34	-	pF
Output Capacitance (VDS = 25 Vdc, VGS = 0, f = 1.0 MHz)	Coss	-	3	-	pF
Reverse Transfer Capacitance (VDS = 25 Vdc, VGS = 0, f = 1.0 MHz)	Crss	-	2.2	-	pF

**SWITCHING CHARACTERISTICS**

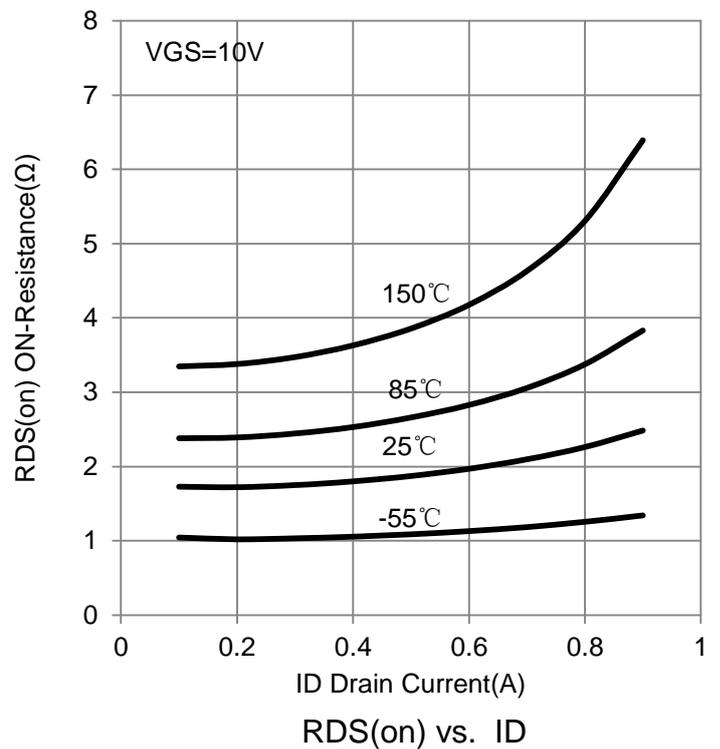
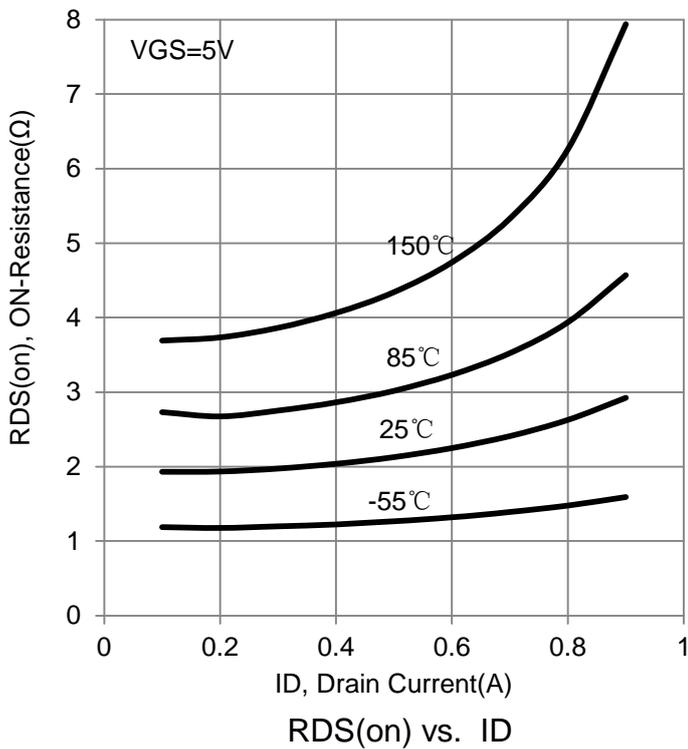
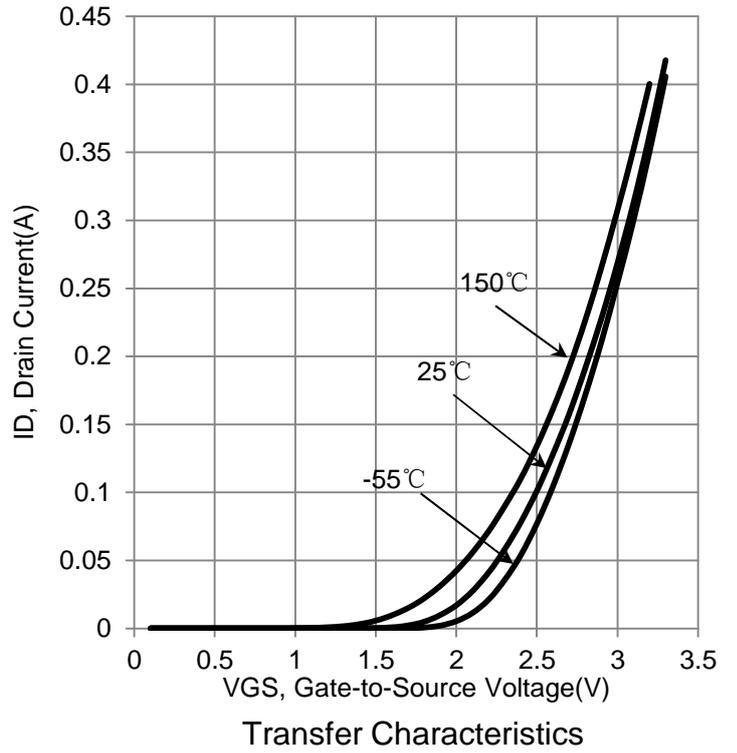
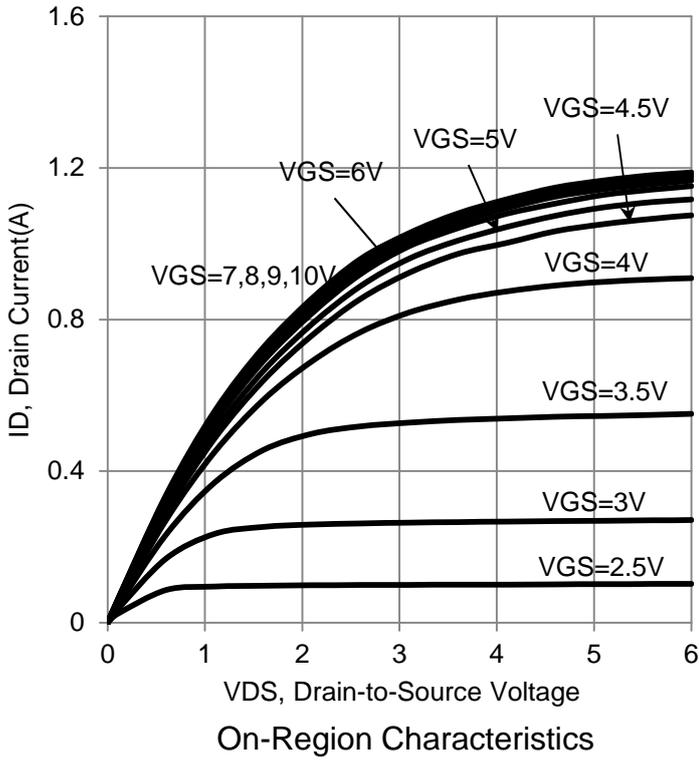
Turn-On Delay Time	VDS = 10 V, VGEN = 10 V, ID = 500 mA	td(on)	-	3.8	-	ns
Rise Time		tr	-	3.4	-	
Turn-Off Delay Time		td(off)	-	19	-	
Fall Time		tf	-	12	-	

**BODY–DRAIN DIODE RATINGS**

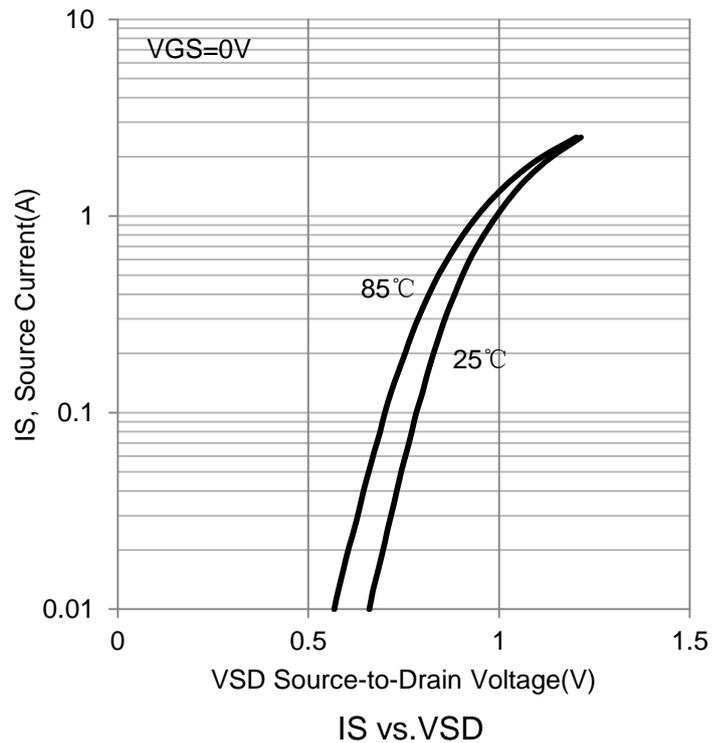
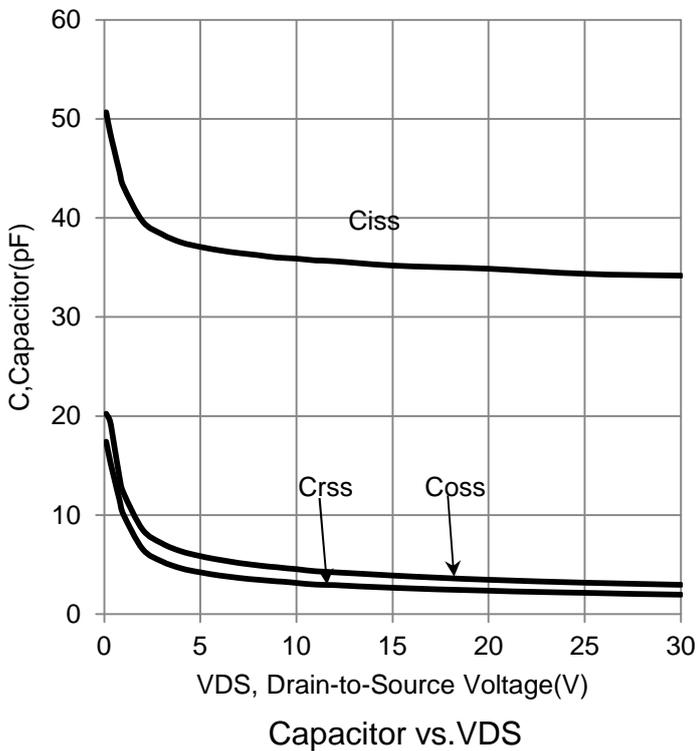
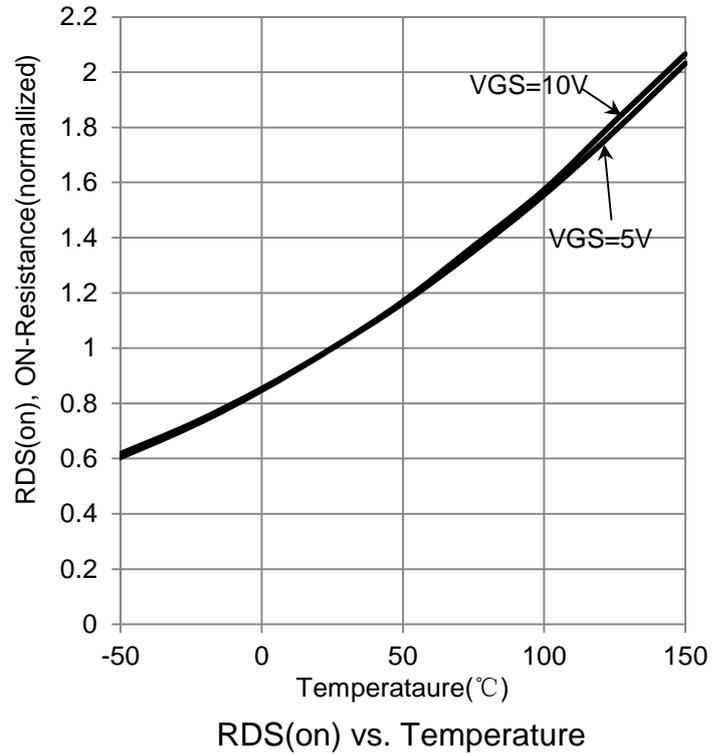
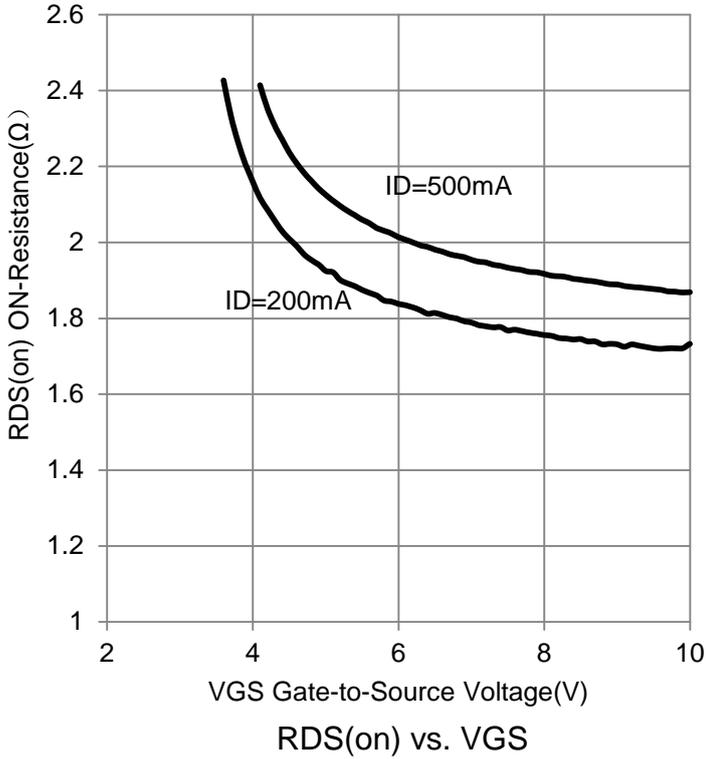
Diode Forward On–Voltage (IS = 115 mAdc, VGS = 0 V)	TJ = 25°C	VSD	-	-	1.4	Vdc
	TJ = 85°C		-	0.7	-	

 2.Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

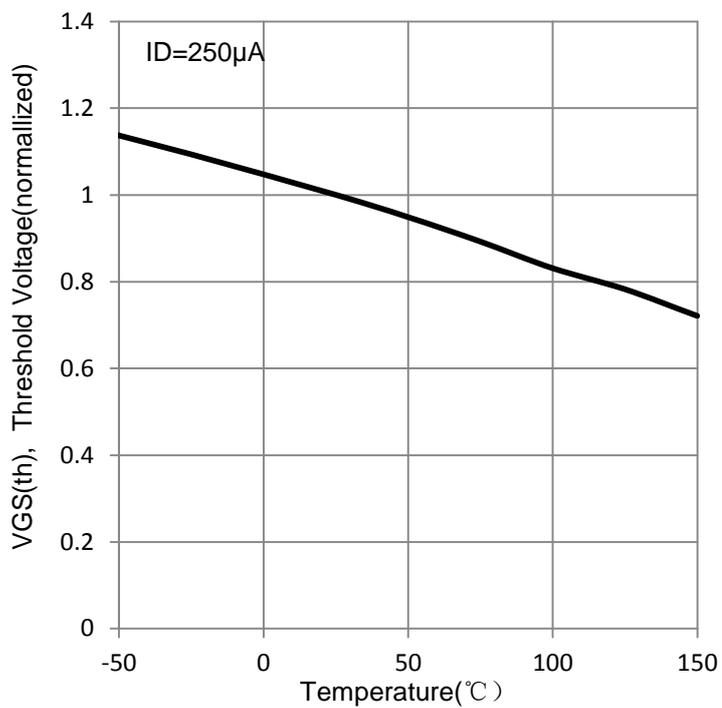
### ELECTRICAL CHARACTERISTICS CURVES



### ELECTRICAL CHARACTERISTICS CURVES (Con.)



### ELECTRICAL CHARACTERISTICS CURVES (Con.)



VGS(th) vs. Temperature



## NOTICE

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